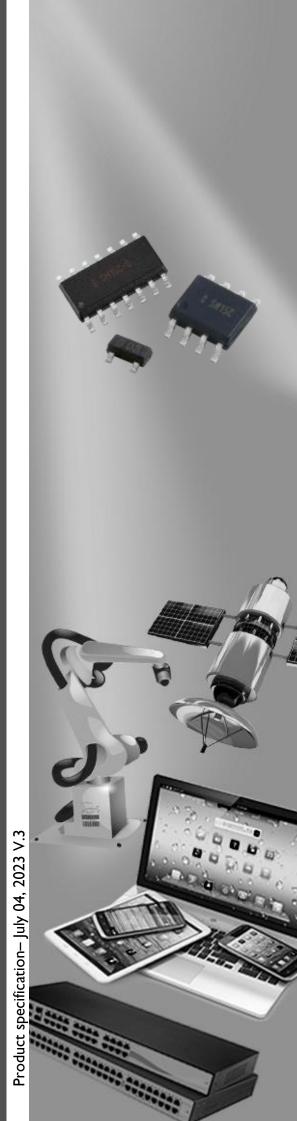


# **DATA SHEET**

ELECTROSTATIC DISCHARGE PROTECTION DEVICES INDUSTRIAL / CONSUMER UDS08A03L04

RoHS compliant & Halogen free





# Electrostatic Discharged Protection Devices (ESD) Data Sheet

#### **Description**

The UDS08A03L04 component is designed to protect low voltage state-of-the-art CMOS semiconductors from transients caused by electrostatic discharge (ESD), cable discharge events (CDE), lightning and other induced voltage surges. The device provides low stand-off voltages with significant reductions in leakage currents and capacitance over silicon avalanche diode processes.

The UDS08A03L04 features integrated low capacitance compensation diodes that reduce the typical capacitance 3pF per line.

This combined with low leakage current, means signal integrity preserved in high-speed applications such as 10/100/1000 Ethernet.

#### **Features**

- IEC61000-4-2 ESD 30KV Air, 30KV contact compliance
- SOIC-08 surface mount package
- Protects four I/O lines
- Peak power dissipation of 400W under 8/20µs waveform
- Working voltage: 3.3V
- Low leakage current
- Low operating and clamping voltages
- Solid-state silicon avalanche technology
- Lead Free/RoHS compliant
- Solder reflow temperature: Pure Tin-Sn, 260~270°C
- Flammability rating UL 94V-0
- Meets MSL level 1, per J-STD-020
- Marking: B SLVU03-4

#### **Applications**

- 10/100/1000 Ethernet
- WAN/LAN Equipment
- High current switching systems
- Desktops, Servers and Notebook

- Instrumentation
- Analog inputs
- Base stations

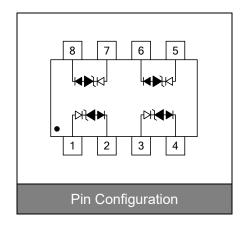
### **Maximum Ratings**

Rating	Symbol	Value	Unit	
ESD voltage (Contact discharge)	V	±30	kV	
ESD voltage (Air discharge)	$V_{ESD}$	±30		
Storage & operating temperature range	T <sub>STG</sub> ,T <sub>J</sub>	-55~+150	$^{\circ}$	



Contact: ±30kV Air: ±30kV



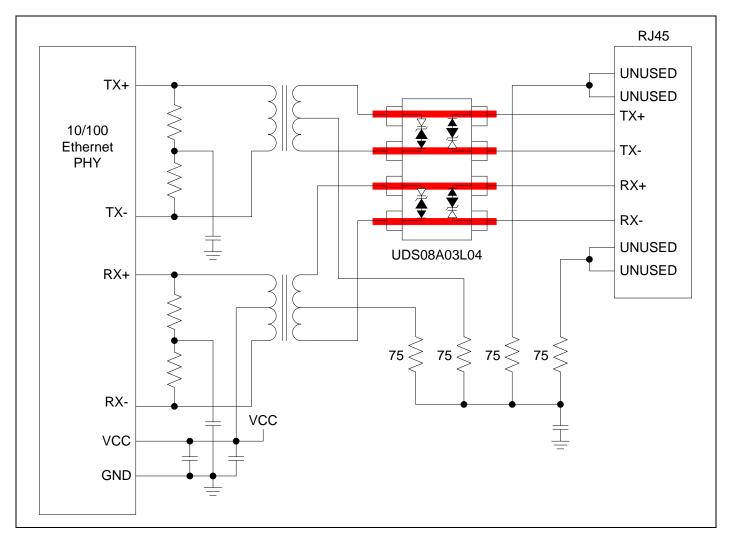


#### Electrical Characteristics (T<sub>J</sub>=25°C)

Parameter	Symbol	Condition	Min.	Max.	Unit
Reverse stand-off voltage	V <sub>RWM</sub>			3.3	V
Reverse breakdown voltage	$V_{BR}$	I <sub>BR</sub> =1mA	4.5		V
Reverse leakage current	I <sub>R</sub>	V <sub>R</sub> =3.3V Each I/O pin		0.1	uA
Clamping voltage (tp=8/20µs)	Vc	I <sub>PP</sub> =5A		12.5	V
Peak pulse current (tp=8/20µs)	I <sub>PP</sub>			20	Α
Off state junction capacitance	CJ	0Vdc,f=1MHz Between I/O pins and GND		1.8	pF
		0Vdc,f=1MHz Line to Line, two I/O pins connected together on each line (Note)		3.6	pF

Note: Ratings with two pins connected together per the recommended configuration (ie pin 1 connected to pin 8, pin 2 connected to pin 7, pin 3 connected to pin 6, pin 4 connected to pin 5).

# **Applications Information**



# Electrostatic Discharge Protection Devices UDS08A03L04

#### **Typical Characteristics Curves**

Figure 1. Power Derating Curve

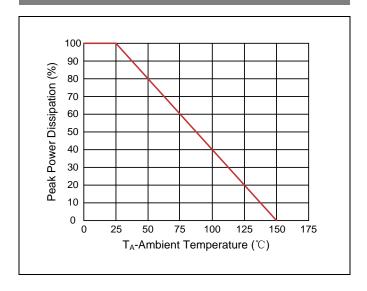


Figure 2. Pulse Waveforms

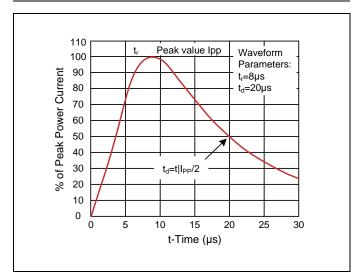


Figure 3. Non-Repetitive Peak Pulse vs. Pulse Time

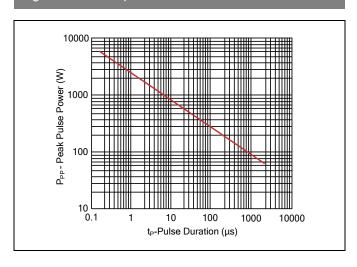


Figure 4. Capacitance vs. Reverse Voltage

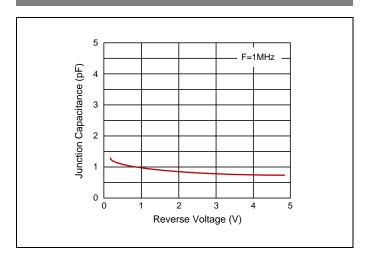
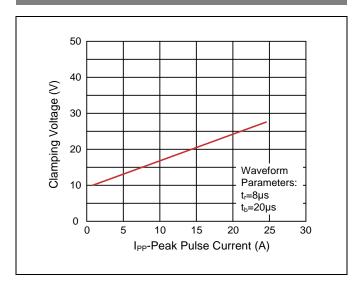


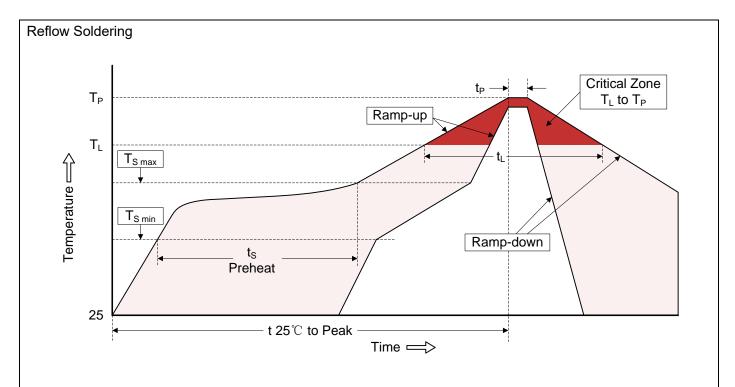
Figure 5. Clamping Voltage vs. Peak Pulse Current





# Electrostatic Discharge Protection Devices UDS08A03L04

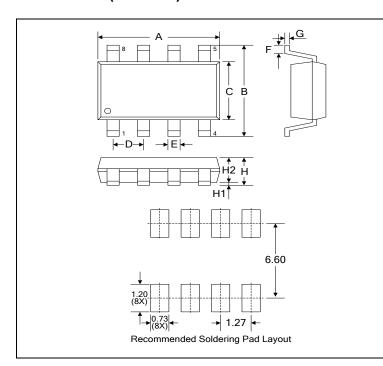
# **Recommended Soldering Conditions**



#### **Recommended Conditions**

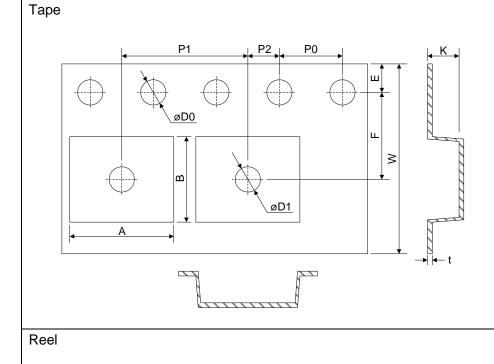
Profile Feature	Pb-Free Assembly	
Average ramp-up rate $(T_L \text{ to } T_P)$	3°ℂ/second max.	
Preheat -Temperature Min (T <sub>S min</sub> ) -Temperature Max (T <sub>S max</sub> ) -Time (min to max) (ts)	150°C 200°C 60-180 seconds	
T <sub>S max</sub> to T <sub>L</sub> -Ramp-up Rate	3°ℂ/second max.	
Time maintained above: -Temperature $(T_L)$ -Time $(t_L)$	217°C 60-150 seconds	
Peak Temperature (T <sub>P</sub> )	260℃	
Time within 5℃ of actual Peak Temperature (t <sub>P</sub> )	20-40 seconds	
Ramp-down Rate	6°ℂ/second max.	
Time 25℃ to Peak Temperature	8 minutes max.	

# **Dimensions (SOIC-08)**



		Dime	nsion	sion		
Symbol	Millimeters		Inches			
	Min.	Max.	Min.	Max.		
Α	4.80	5.00	0.189	0.197		
В	5.80	6.20	0.228	0.244		
С	3.80	4.00	0.150	0.157		
D	1.27		0.050			
Е	0.33	0.51	0.013	0.020		
F	0.40	1.27	0.016	0.050		
G	0.19	0.25	0.007	0.010		
Н	1.35	1.75	0.053	0.069		
H1	0.10	0.25	0.004	0.010		
H2	1.45		0.0	)57		

## **Packaging**



Symbol	Dimension (mm)	
W	12.00±0.30	
P0	4.00±0.10	
P1	8.00±0.10	
P2	2.00±0.10	
D0	Ф1.55±0.10	
D1	Ф1.55±0.05	
Е	1.75±0.10	
F	5.50±0.10	
А	6.50±0.10	
В	5.40±0.10	
K	2.00±0.10	
t	0.30±0.05	
D	Ф330.0±3.0	
D2	Ф13.0	
W1	13.5	
Quantity: 2500PCS		





#### **Circuit Protection Components**

#### LEGAL DISCLAIMER

YAGEO, its distributors and agents (collectively, "YAGEO"), hereby disclaims any and all liabilities for any errors, inaccuracies or incompleteness contained in any product related information, including but not limited to product specifications, datasheets, pictures and/or graphics. YAGEO may make changes, modifications and/or improvements to product related information at any time and without notice.

YAGEO makes no representation, warranty, and/or guarantee about the fitness of its products for any particular purpose or the continuing production of any of its products. To the maximum extent permitted by law, YAGEO disclaims (i) any and all liability arising out of the application or use of any YAGEO product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for a particular purpose, non -infringement and merchantability.

YAGEO products are designed for general purpose applications under normal operation and usage conditions. Please contact YAGEO for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property: Aerospace equipment (artificial satellite, rocket, etc.), Atomic energy-related equipment, Aviation equipment, Disaster prevention equipment, crime prevention equipment, Electric heating apparatus, burning equipment, Highly public information network equipment, data-processing equipment, Medical devices, Military equipment, Power generation control equipment, Safety equipment, Traffic signal equipment, Transportation equipment and Undersea equipment, or for any other application or use in which the failure of YAGEO products could result in personal injury or death, or serious property damage. Particularly YAGEO Corporation and its affiliates do not recommend the use of commercial or automotive grade products for high reliability applications or manned space flight.

Information provided here is intended to indicate product specifications only. YAGEO reserves all the rights for revising this content without further notification, as long as products are unchanged. Any product change will be announced by PCN.